

✓ Search ...

PRODUCTS | APPLICATIONS | DESIGN SUPPORT | TRAINING | SAMPLE AND BUY | ABOUT US | CONTACT US | myMicrochip Login

Product Change Notification - B2M2000004 - JAON-08DHBR103

| | | • | | | | | | | | |
|-----------------------|---|--|--|--|--|--|--|--|--|--|
| Date: | 05 Jul 2016 | | | | | | | | | |
| Product Category: | Analog (Thermal, Power Man | Analog (Thermal, Power Management & Safety) | | | | | | | | |
| Notification subject: | CCB 1737.06 Final Notice: Release to production of listed Micrel MOSFET Driver product type | | | | | | | | | |
| Notification text: | manufactured with the B2M2 process technology to Microchip Fab. PCN Status: Final Notification | | | | | | | | | |
| | | ains to the products listed in this product type and process technol | PCN. Additional final PCNs may b blogy. | | | | | | | |
| | Microchip Parts Affected: Please open the attachments | found in the attachments field be | elow labeled as PCN_#_Affected_0 | | | | | | | |
| | NOTE: For your convenience | Microchip includes identical files | in two formats (.pdf and .xls). | | | | | | | |
| | Description of Change: Release to production of listed process technology to Microch | | type manufactured with the B2M2 | | | | | | | |
| | NOTE: Please review the FAC |) linked <u>here</u> for additional inforr | nation about this change. | | | | | | | |
| | Pre Change: Fabricated at Micrel fabrication | n site (San Jose, CA, USA) usin | g 6 inch wafers. | | | | | | | |
| | Post Change: Fabricated at Microchip fabrica | ation site using 8 inch wafers. | | | | | | | | |
| | Pre and Post Change Summ | ary: | | | | | | | | |
| | | Pre Change | Post Change | | | | | | | |
| | | Micrel fabrication site | | | | | | | | |
| | Fab Site | (San Jose, CA, USA) | Microchip fabrication site | | | | | | | |
| | | | | | | | | | | |

Impacts to Data Sheet: None

Reason for Change:

To improve productivity with the closure of the Micrel fab as part of the integration of Micrel and Microchip.

Change Implementation Status: In Progress

Estimated First Ship Date:

As identified for each CPN listed in the attached parts list.

Summary Time Table of notable events to date:

| | 0 | Sep | oten 201 | nbe 5 | er | > | April 2016 | | | > | June 2016 | | | | | July 2016 | | | | August 2016 | | | | |
|-----------------------------------|----|-----|-------------|----------|----|---|---------------|----|----|----|-----------|----|----|----|----|-----------|----|----|----|-------------|----|--|----|----|
| Workweek | 36 | 37 | 38 | 39 | 40 | | 14 | 15 | 16 | 17 | | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 | 32 | 33 | 30 |
| Initial PCN Issue Date | | | | | | | | | | | | | | | | | | | | | | | | |
| CYER- 31JLEX869 | х | | | | | | | | | | | | | | | | | | | | | | | |
| Qual Report Available | | | | | | | | | | | | | | | | | | | | | | | | |
| JAON- 08DHBR103 | | | | | | | | х | | | | | | | | | | | | | | | | |
| Final PCN Issue Date | | | | | | | | | | | | | | | | | | | | | | | | |
| JAON- 08DHBR103- B2M2000004 | | | | | | | | | | | | | | | | | х | | | | | | | |
| Estimated First Ship Date | | | | | | | | | | | | | | | | | | | | | | As listed in the attached parts list. | | |

Markings to Distinguish Revised from Unrevised Devices:

Traceability code and shipping label see FAQ.

Revision History:

September 1, 2015: Issued initial notification as PCN number CYER-31JLEX869 April 12, 2016: Issued intermediate notification as PCN number JAON-08DHBR103. Attached the Qualification Report. Revised the estimated first ship date (EFSD) to inform that the EFSD will be revealed in the final PCN.

July 5, 2016: Issued final notification as PCN number JAON-08DHBR103-B2M2000004 for listed Micrel's MOSFET Driver products manufactured with the B2M2 process technology. Provided estimated first ship date (EFSD) for each CPN listed in the attached parts list.

The change described in this PCN does not alter Micrel's or Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-08DHBR103_Qual Report.pdf PCN_JAON-08DHBR103-B2M2000004_Affected_CPN.pdf PCN_JAON-08DHBR103-B2M2000004_Affected_CPN.xls Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to change your product/process change notification (PCN) profile please log on to our website at http://www.microchip.com/PCN sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to microchipDIRECT and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."



Products | Applications | Design Support | Training | Sample and Buy | About Us | Contact Us | Legal | Investors | Careers | Support

©Copyright 1998-2016 Microchip Technology Inc. All rights reserved. Shanghai ICP Recordal No.09049794 JAON-08DHBR103-B2M2000004 - CCB 1737.06 Final Notice: Release to production of listed Micrel MOSFET Driver product type manufactured with the B2M2 process technology to Microchip Fab.

Affected Catalog Part Numbers (CPN)

| PCN_JAON-08DHBR103-B2M2000004 | | | | | | | | |
|-------------------------------|----------------------------------|--|--|--|--|--|--|--|
| CATALOG_PART_NBR | Estimated First Ship Date (EFSD) | | | | | | | |
| MIC4604YM | August 11, 2016 | | | | | | | |
| MIC4604YM-T5 | August 11, 2016 | | | | | | | |
| MIC4604YM-TR | August 11, 2016 | | | | | | | |
| MIC4604YMT-T5 | August 11, 2016 | | | | | | | |
| MIC4604YMT-TR | August 11, 2016 | | | | | | | |